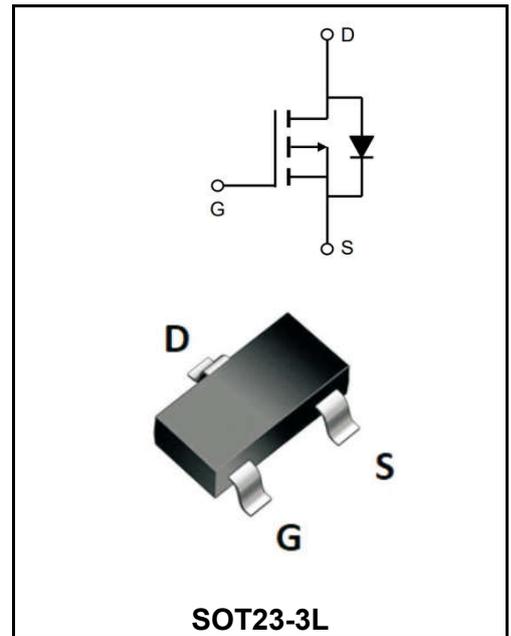


**-12V P-CHANNEL ENHANCEMENT MODE MOSFET**

**MAIN CHARACTERISTICS**

<b>I<sub>D</sub></b>	-7.0A
<b>V<sub>DSS</sub></b>	-12V
<b>R<sub>DS(on)-typ</sub>(@V<sub>GS</sub>=-4.5V)</b>	< 24mΩ( <b>Type:19 mΩ</b> )



**Application**

- ◆electronic cigarette
- ◆Load switch

<b>Marking Code</b>	
YFW2311MI	20P07

**Maximum Ratings at T<sub>c</sub>=25°C unless otherwise specified**

Characteristics	Symbols	Value	Units
Drain-Source Voltage	<b>V<sub>DS</sub></b>	-12	<b>V</b>
Gate - Source Voltage	<b>V<sub>GS</sub></b>	± 12	<b>V</b>
Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> @T <sub>c</sub> =25°C	<b>I<sub>D</sub></b>	-7.0	<b>A</b>
Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> @T <sub>c</sub> =100°C	<b>I<sub>D</sub></b>	-3.6	<b>A</b>
Pulsed Drain Current <sup>note1</sup>	<b>I<sub>DM</sub></b>	-22	<b>A</b>
Power Dissipation @T <sub>c</sub> =25°C	<b>P<sub>D</sub></b>	1.6	<b>W</b>
Thermal Resistance Junction-Ambient	<b>R<sub>θJA</sub></b>	125	<b>°C/W</b>
Operating Junction Temperature Range	<b>T<sub>J</sub> , T<sub>STG</sub></b>	-55 to +150	<b>°C</b>

**Maximum Ratings at Tc=25°C unless otherwise specified**

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	<b>V(BR)DSS</b>	-12	-18	-	<b>V</b>
Zero Gate Voltage Drain Current	$V_{DS}=-12V, V_{GS}=0V$	<b>I<sub>DSS</sub></b>	-	-	-1	<b>μA</b>
Gate to Body Leakage Current	$V_{GS}=\pm 12V, V_{DS}=0V$	<b>I<sub>GSS</sub></b>	-	-	±100	<b>nA</b>
Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	<b>V<sub>GS(th)</sub></b>	-0.5	-0.65	-1.0	<b>V</b>
Static Drain-Source on-Resistance note2	$V_{GS}=-4.5V, I_D=-5.2A$	<b>R<sub>DS(ON)</sub></b>	-	19	24	<b>mΩ</b>
	$V_{GS}=-2.5V, I_D=-4.2A$		-	28	35	
Input Capacitance	$V_{DS}=-6V$ $V_{GS}=0V$ $f=1MHz$	<b>C<sub>iss</sub></b>	-	1100	-	<b>pF</b>
Output Capacitance		<b>C<sub>oss</sub></b>	-	390	-	
Reverse Transfer Capacitance		<b>C<sub>rss</sub></b>	-	300	-	
Total Gate Charge	$V_{DS}=-4V$ $I_D=-4.1A$ $V_{GS}=-4.5V$	<b>Q<sub>g</sub></b>	-	11.5	-	<b>nC</b>
Gate-Source Charge		<b>Q<sub>gs</sub></b>	-	1.5	-	
Gate-Drain("Miller") Charge		<b>Q<sub>gd</sub></b>	-	3.2	-	
Turn-on delay time	$V_{DD}=-4V$ $I_D=-3.3A$ $R_G=1.0\Omega$ $V_{GEN}=-4.5V$ $R_L=1.2\Omega$	<b>t<sub>d(on)</sub></b>	-	25	-	<b>ns</b>
Turn-on Rise Time		<b>T<sub>r</sub></b>	-	45	-	
Turn-Off Delay Time		<b>t<sub>d(OFF)</sub></b>	-	72	-	
Turn-Off Fall Time		<b>t<sub>f</sub></b>	-	60	-	
Maximum Continuous Drain to Source Diode Forward Current		<b>I<sub>S</sub></b>	-	-	-6.0	<b>A</b>
Maximum Pulsed Drain to Source Diode Forward Current		<b>I<sub>SM</sub></b>	-	-	-16	<b>A</b>
Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S=-4.1A$	<b>V<sub>SD</sub></b>	-	-	-1.2	<b>V</b>
Reverse Recovery Time	$I_S=-4.1A, dI/dt=100A/\mu s,$ $V_{GS}=0V$	<b>t<sub>rr</sub></b>	-	20	-	<b>ns</b>
Reverse Recovery Charge		<b>Q<sub>rr</sub></b>	-	9	-	<b>nC</b>

Note :

- 1、 The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width  $\cong 300\mu s$  , duty cycle  $\cong 2\%$
- 3、 The power dissipation is limited by 150°C junction temperature
- 4、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

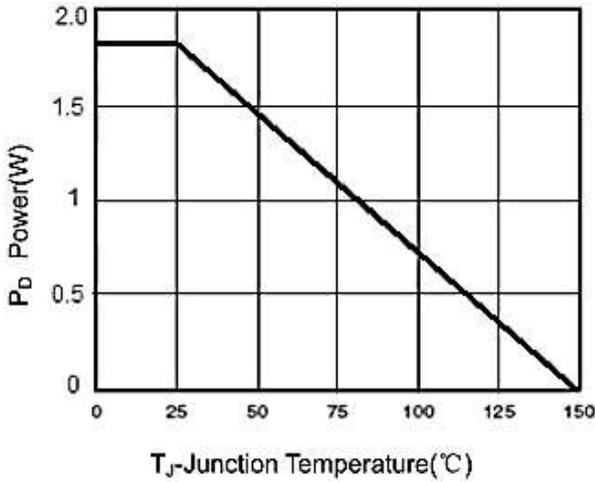


Figure 1 Power Dissipation

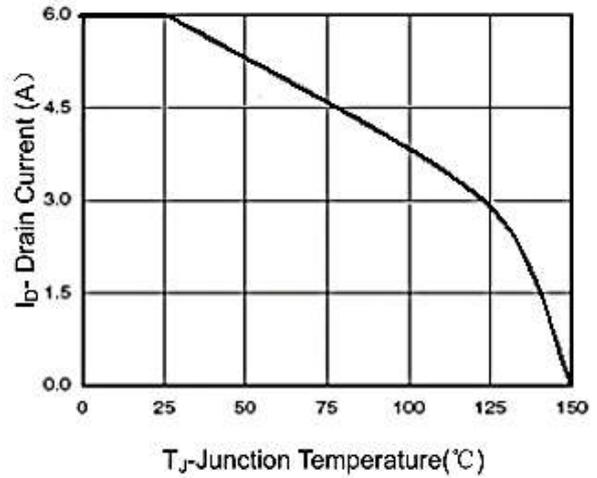


Figure 2 Drain Current

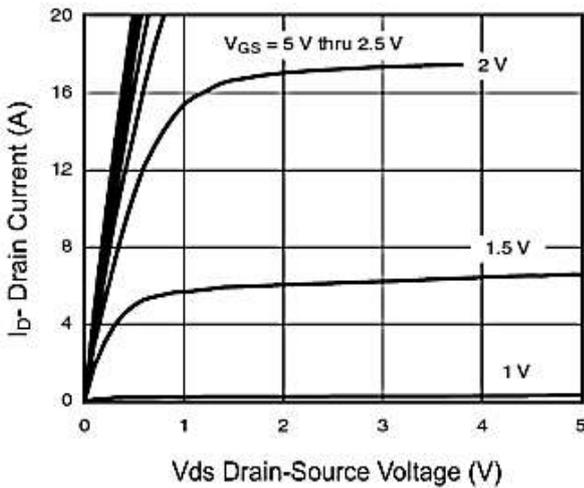


Figure 3 Output Characteristics

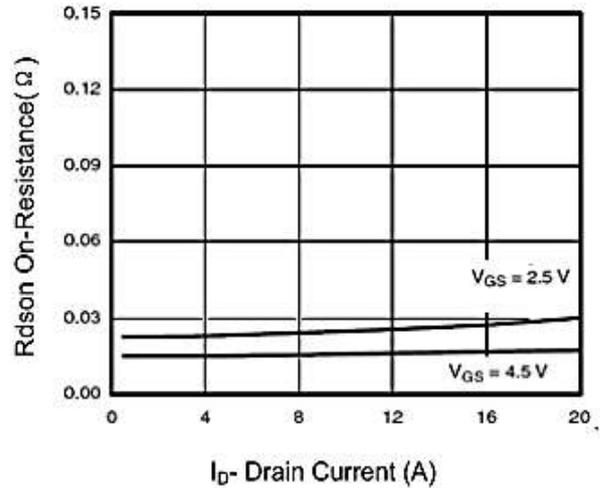


Figure 4 Drain-Source On-Resistance

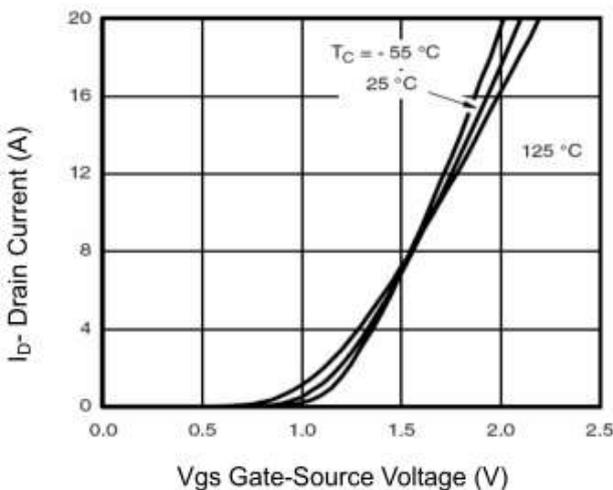


Figure 5 Transfer Characteristics

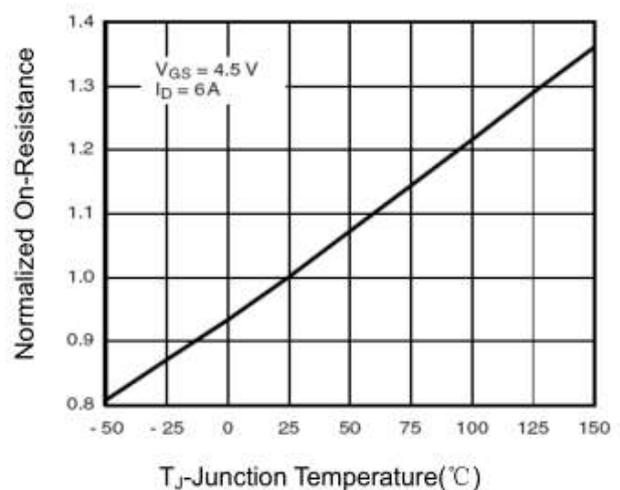
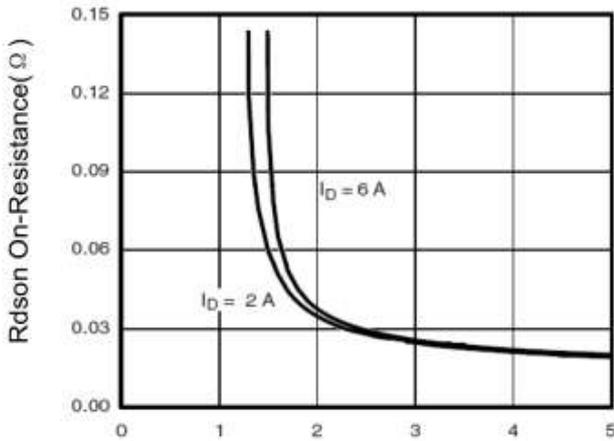
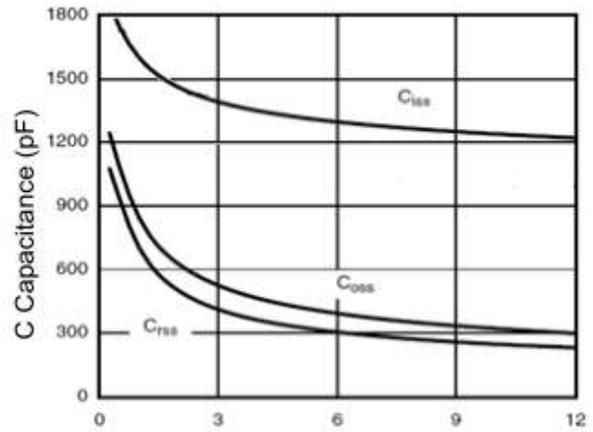


Figure 6 Drain-Source On-Resistance

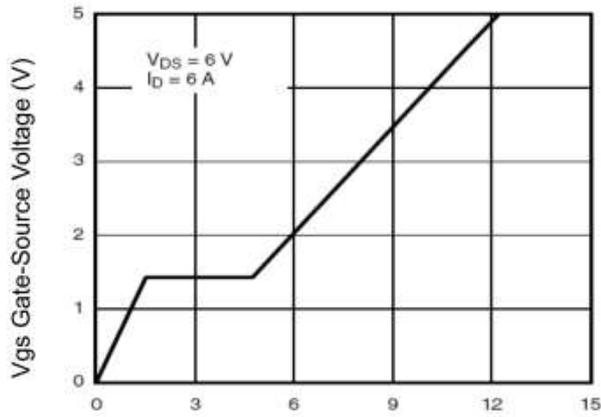
Ratings and Characteristic Curves



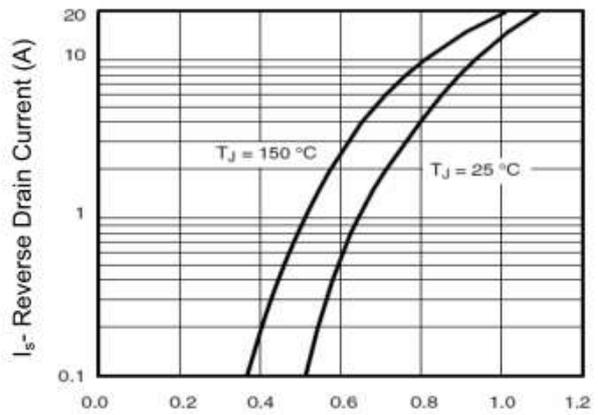
Vgs Gate-Source Voltage (V)  
**Figure 7 Rdson vs Vgs**



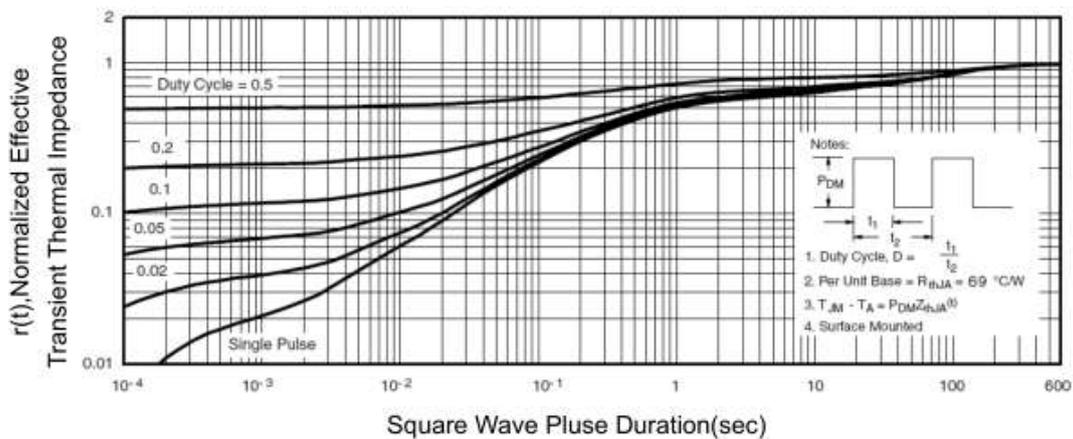
Vds Drain-Source Voltage (V)  
**Figure 8 Capacitance vs Vds**



Qg Gate Charge (nC)  
**Figure 9 Gate Charge**



Vsd Source-Drain Voltage (V)  
**Figure 10 Source- Drain Diode Forward**



**Figure 12 Normalized Maximum Transient Thermal Impedance**

Ordering information

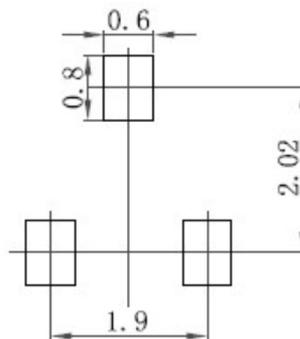
Package	Packing Description	Base Quantity	Packing Quantity
SOT23-3L	Tape/Reel, 7" reel	3000pcs/Reel	24000PCS/Box 120000PCS/Carton

Package Dimensions

SOT23-3L

Dim.	Millimeter (mm)		mil	
	Min.	Max.	Min.	Max.
A	1.05	1.25	41	49.2
A1	0.10		3.93	
A2	1.05	1.15	41	45
b	0.30	0.50	12	20
c	0.10	0.20	3.93	7.9
D	2.82	3.02	111	119
E	1.50	1.70	59	67
E1	2.65	2.95	104	116
e	0.95		37.4	
e1	1.80	2.00	71	78
L	0.30	0.066	12	26
Θ	8°			

The recommended mounting pad size



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